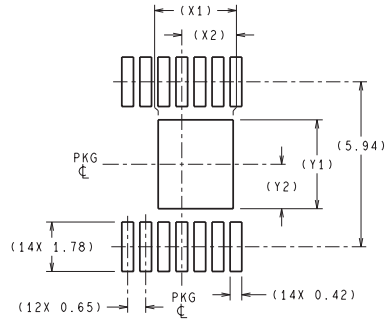
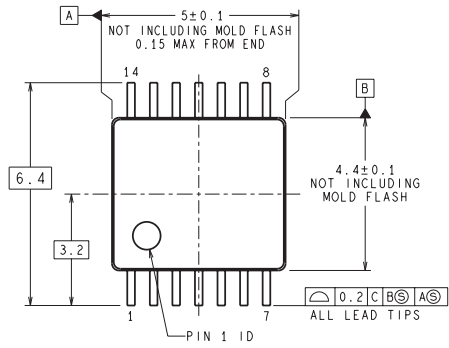
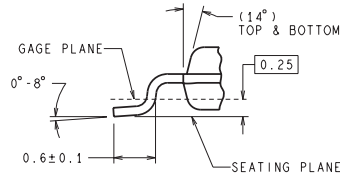
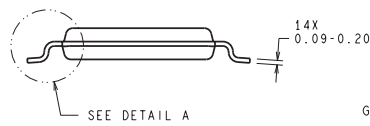
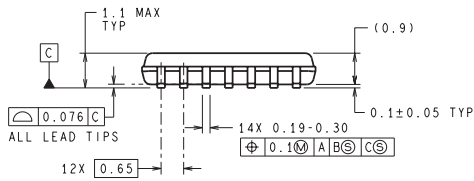


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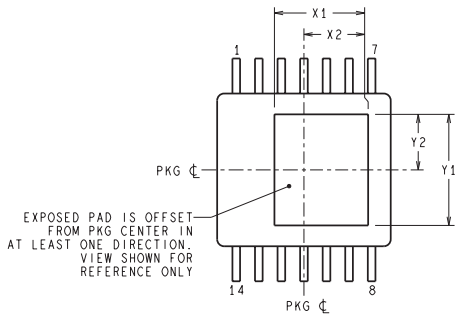


RECOMMENDED LAND PATTERN



DETAIL A TYPICAL

DIMENSIONS ARE IN MILLIMETERS
DIMENSIONS IN () FOR REFERENCE ONLY



PAD SIZE CODE IN DWG No. (XX)	PAD SIZE		X2	Y2
	X1	Y1		
AA	2.7	3.2	1.85	1.6

MYB14XX (Rev B)

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